### **Overview**

### **HP EliteBook 850 G8 Notebook PC**



### Left

- 1. Ambient Lights Sensor (Optional)
- 2. Internal Microphones (2)
- 3. Webcam LED (Optional)
- 4. Camera Shutter
- 5. HD and IR Camera (Optional)
- 6. IR Camera LEDs (Optional)
- 1. SuperSpeed USB 20Gbps is not available.

- 7. Glass Clickpad
- 8. Smartcard Reader (Optional)
- 9. Audio Combo Jack
- 10. SuperSpeed USB Type-A 5Gbps signaling rate 1
- 11 Nano Security Lock Slot (Lock sold separately)

### **Overview**



- 1. Power Connector
- 2. USB 3.1 Gen 1 Port
- 3. HDMI Port 2.0b (Cable not included)
- 4. SuperSpeed USB Type-C® 5Gbps signaling rate 1
- Right
  - 5. SuperSpeed USB Type-C® 5Gbps signaling rate 1
  - **6.** SIM Card Slot (Optional)
  - 7. Touch Fingerprint Sensor (Select models)

1. SuperSpeed USB 20Gbps is not available.

### Overview

### **AT A GLANCE**

- Premium ultraslim design with precision-crafted machined aluminum (CNC) chassis for a premium look and feel
- 11th Generation Intel® Core™ i5, i7 Processors up to four-core
- Preinstalled with Windows 10 versions or FreeDOS
- Designed to support all HP docking options including the HP Universal Dock G5
- Featuring redesigned guiet HP Keyboard with the HP Programmable key and backlit options
- Innovative world-facing third mic improves inbound ambient noise cancellation while 360 degree mic pick-up allows everyone to clearly hear and be heard
- Optional ultrabright displays with ambient light sensor
- Choice of displays:
  - 39.6 cm (15.6") diagonal FHD IPS Anti-Glare LED-backlit, 250 nits, 45% NTSC
    39.6 cm (15.6") diagonal FHD IPS Anti-Glare LED-backlit non-touch 400 nits, 72% NTSC
    39.6cm (15.6") diagonal UHD IPS Anti-Glare LED-backlit non-touch, 400 nits, 72% NTSC
    39.6cm (15.6") diagonal FHD IPS Anti-Glare On-Cell LED-backlit touch, 250 nits, 45% NTSC
    39.6cm (15.6") diagonal FHD IPS Anti-Glare LED-backlit non-touch, 1000 nits, 100% sRGB with HP Sure View Reflect
- Enterprise grade security with HP Sure Sense, HP Sure Start Gen6, HP Privacy Camera, HP Sure View Reflect, HP Sure Run Gen4, HP Sure Recover Gen4 with Embedded Reimaging, HP Sure Click, SmartCard Reader and Touch Fingerprint reader
- Connectivity with optional CAT20 5G/ WWAN, and Thunderbolt™ Docking (Dock sold separately)
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Choice of solid state drives up to 2 TB and DDR4 memory up to 64 GB
- Undergoes 21 MIL-STD 810G tests<sup>1</sup>
- Choose from MX 450 N18S-G5 or Intel® Iris® Xe Graphics

1. MIL-STD 810G is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



### **Technical Specifications**

### **PRODUCT NAME**

HP EliteBook 850 G8 Notebook PC

#### **OPERATING SYSTEM**

Preinstalled Windows 10 Pro 64 – HP recommends Windows 10 Pro for business<sup>1</sup>

Windows 10 Pro 64 (National Academic License)1,2

Windows 10 Home 641

Windows 10 Home Single Language 641

Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)<sup>1</sup>

Windows 10 Enterprise 64 (Web Support) 1

**FreeDOS** 

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com/">http://www.windows.com/</a>.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

### **PROCESSORS**

Intel® Core™ i7-1165G7 (2.8 GHz base frequency, up to 4.7 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) 3.4.5.6

Intel® Core™ i5-1135G7 (2.4 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) 3,4,5,6

#### **Processor Family**

11th Generation Intel® Core™ i7 processor (i7-1165G7)<sup>6</sup> 11th Generation Intel® Core™ i5 processor (i5-1135G7)<sup>6</sup>

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

#### **GRAPHICS**



## **Technical Specifications**

#### Integrated

Intel® Iris® Xe Graphics7

#### Discrete

MX 450 N18S-G5

#### Supports

HD decode, DX12, HDMI 2.0b, HDCP 2.38

7. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.

8. HDMI cable sold separately.

### **DISPLAY**

#### Non-Touch

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC (1920x1080) 9,10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for HD camera (1920x1080) 9,10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for HD + IR camera (1920x1080) 9.10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for WWAN (1920x1080) 9.10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for HD camera for WWAN (1920x1080) 9.10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for HD + IR camera for WWAN (1920x1080) 9,10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP+PSR, 400 nits, 100% SRGB, Low Power Ambient Light Sensor for HD+IR Camera (1920x1080) 9,10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP+PSR, 400 nits, 100% SRGB, Low Power Ambient Light Sensor for HD+IR Camera for WWAN (1920x1080) 9,10

39.6 cm (15.6") diagonal UHD Bent, anti-glare UWVA eDP+PSR, 400 nits, 100% SRGB, Low Power Ambient Light Sensor for HD+IR Camera (1920x1080) 9,10

39.6 cm (15.6") diagonal UHD Bent, anti-glare UWVA eDP+PSR, 400 nits, 100% SRGB, Low Power Ambient Light Sensor for HD+IR Camera for WWAN (1920x1080) 9,10

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor for HD camera (1920x1080) 9,10,11,12

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor for HD + IR camera (1920x1080) 9,10,11,12

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor for HD camera for WWAN (1920x1080) 9,10,11,12

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor for HD + IR camera for WWAN (1920x1080) 9,10,11,12

### Touch

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for HD+IR camera Touch on Panel (1920x1080) 9,10,11,12

39.6 cm (15.6") diagonal FHD Bent, anti-glare UWVA eDP, 250 nits, 45% NTSC for HD+IR camera for WWAN Touch on Panel (1920x1080) 9,10,11,12

HDMI 2.0<sup>13</sup>



## Technical Specifications

Support resolution up to 4K @60 Hz

- 9. FHD/HD content required to view FHD/HD images.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 11. Actual brightness will be lower with touchscreen or Sure View.
- 12. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 13. HDMI cable sold separately.

Docking	Total	Max	Dock	Technical limitations / additional information
station	number of	resolutions	Connectors	For more details refer to HP Dock QuickSpecs
model	supported	supported for		http://h20195.www2.hp.com/v2/GetDocume
(Sold	displays	DP 1.4 hosts		nt.aspx?docname=c04168358
separately)	(incl. the	with DSC		
	notebook)			All information below applies to platforms
	display)			running DP 1.4 with DSC
HP Thunderbolt	Max	Dual 8K@ 60Hz in	2xDP, 1xVGA,	Max displays = 4 with max resolution of 5K@
Dock G2	number of displays	high res mode	1xTB, 1xUSB-C alt-mode	30Hz running Thunderbolt host
	= 4		att mode	Max resolution possible is dual 8K displays @
				60Hz running Thunderbolt host or running a
				non-Thunderbolt host in High Resolution
				mode
				The highest resolution for dual displays
				running a non-Thunderbolt host in Multi-
				function mode is one 5K dual cable (using
				both DP ports) + one 4K on USB-C DP port
HP USB-C	3	Dual 5K@ 30Hz +	1xHDMI, 2xDP	Three maximum displays supported are two
Dock G5		1 4K UHD (multi-		5K@ 30 Hz on DP ports plus one 4K UHD@ 30
		function mode)		Hz on HDMI in Multi-function mode
				Highest resolution with dual displays is two
				8K@ 60Hz host in High Resolution mode
				The highest resolution for running a non-
				Thunderbolt host in Multi-function mode is a
				single 5K dual cable (using both DP ports) +
				one 4K on HDMI port



## Technical Specifications

HP USB-C/A	3	Triple 4K UHD@	1xHDMI, 2xDP	
Universal Dock G2		60Hz		In High Resolution, mode the max available is one display. This dock's best use case is triple display.
				The best resolution for dual display is two 4K UHD@ 60Hz
				Highest triple displays resolution available is three 4KUHD @60Hz using both DP and 1 HDMI port.
				Best single display is with High Resolution mode using HDMI port.
HP USB-C Travel Dock G2	1	Single 4K@ 30 Hz 4960 x 2160 (via HDMI)	1xHDMI, 1xVGA	Single external display using either HDMI or VGA



### **Technical Specifications**

### STORAGE AND DRIVES

### **Primary M.2 Storage**

128 GB PCIe® Gen3x2 NVMe™ M.2 SSD TLC¹⁴

256 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹⁴

512 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹⁴

1 TB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹⁴

2 TB PCIe® Gen3x4 NVMe™ M.2 SSD TLC¹⁴

256 GB PCIe® NVMe™ Value M.2 SSD¹⁴

512 GB PCIe® NVMe™ Value M.2 SSD¹⁴

512 GB PCIe® Gen3x4 NVMe™ M.2 SED TLC OPAL2¹⁴

256 GB PCIe® Gen3x4 NVMe™ M.2 SED TLC OPAL2¹⁴

512 Intel® PCIe® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10¹⁴,15

14. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

15. Intel® Optane™ H10 memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

#### **MEMORY**

#### **Maximum Memory**

64 GB DDR4-3200 SDRAM

#### Memory

64 GB DDR4-3200 SDRAM (2 x 32 GB)<sup>16</sup>
32 GB DDR4-3200 SDRAM (2 x 16 GB)<sup>16</sup>
16 GB DDR4-3200 SDRAM (2 x 8 GB)<sup>16</sup>
16 GB DDR4-3200 SDRAM (1 x 16 GB)<sup>16</sup>
8 GB DDR4-3200 SDRAM (1 x 8 GB)<sup>16</sup>
8 GB DDR4-3200 SDRAM (2 x 4 GB)<sup>16</sup>
4 GB DDR4-3200 SDRAM (1 x 4 GB)<sup>16</sup>

#### **Memory Slots**

2 SODIMM DDR4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

16. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



## **Technical Specifications**

### **NETWORKING/COMMUNICATIONS**

#### WLAN

Intel®Dual Band Wi-Fi® 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5 Combo, non-vPro®17 Intel® Dual Band Wi-Fi® 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5 Combo, vPro®17,18

#### **WWAN**

Intel® XMM™ 7360 LTE-Advanced Cat 9 <sup>19</sup>
Qualcomm® Snapdragon™ X55 5G Cat 20 <sup>20</sup>

Near Field Communications (NFC) Module <sup>22</sup> HP Module with NXP NFC Controller NPC300 12C NCI

#### Miracast

Native Miracast Support<sup>21</sup>

17. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.

18. For full Intel® vPro™ functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required. See https://www.intel.com/content/www/us/en/architecture-and-technology/vpro/vpro-platform-general.html

19. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions.

- 20. 5G module is an optional feature that must be configured at purchase. AT&T and T-Mobile networks supported in the U.S. Module designed for 5G networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 5G not available on all products, in all regions. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select countries, where carrier supported.
- 21. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 22. Sold separately or as an optional feature.

### **AUDIO/MULTIMEDIA**

#### Audio

Audio by Bang & Olufsen
2 Integrated stereo speakers
Integrated dual array microphone
World- Facing microphone

#### Camera

720p HD camera<sup>9,22</sup> 720p HD+IR camera<sup>9,22</sup>



## **Technical Specifications**

#### Sensors

Ambient light sensor Hall Sensor HP Tamper Lock 53

- 9. FHD/HD content required to view FHD/HD images.
- 22. Sold separately or as an optional feature.
- 53. HP Tamper Lock must be enabled by the customer or your administrator.

### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard - spill-resistant, backlit keyboard<sup>23</sup>

### **Pointing Device**

Clickpad with multi-touch gesture support, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

### **Function Keys**

- F1 Display Switching
- F2 Blank or Privacy (with LED)
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Airplane Mode
- F12 HP Programmable Key

Print Screen

Power Button (with LED)

#### **Hidden Function Keys**

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

23. Keyboards are made from up to 65% post-consumer recycled plastic.



### **Technical Specifications**

### **SOFTWARE AND SECURITY**

#### **Preinstalled Software**

#### BIOS

HP BIOSphere Gen6<sup>24</sup>
HP Drive Lock & Automatic Drive Lock
BIOS Update via Network
HP Secure Erase<sup>25</sup>
Absolute Persistence Module<sup>26</sup>
HP LAN-Wireless Protection

#### **Software**

HP Connection Optimizer<sup>27</sup> HP Hotkey Support

myHP

HP Support Assistant<sup>28</sup>

HP QuickDrop

**HP Noise Cancellation Software** 

**Touchpoint Customizer for Commercial** 

**HP Notifications** 

**HP Privacy Settings** 

**HP Wireless Button Driver** 

**HP Power Manager** 

HP WorkWell

Tile App<sup>29</sup>

**HP PC Hardware Diagnostics Windows** 

Buy Microsoft Office (Sold separately)

Microsoft Defender<sup>33</sup>

#### **Manageability Features**

HP Driver Packs (download)30

HP Manageability Integration Kit Gen4 (download)31

HP System Software Manager (SSM) (download)

**HP Client Catalog (download)** 

HP Client Management Script Library (download)

**HP Image Assistant (download)** 

### **Client Security Software**

HP Client Security Manager Gen732

### **Security Management**

Setup password (via BIOS)

HP Fingerprint Sensor<sup>34</sup>

Support for chassis padlocks and cable lock devices

HP Pro Security Edition (Select models) 54

HP Sure Click<sup>35</sup>

HP Sure Sense 49



### **Technical Specifications**

HP Sure Start Gen6<sup>36</sup>

HP Sure Run Gen4<sup>37</sup>

HP Sure Admin 50

HP Sure Recover Gen4<sup>38</sup>

TPM 2.0 Embedded Security Chip shipped with Windows 10

(Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)39

24. HP BIOSphere Gen6 is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations

25. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

26. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years.

Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

https://www.absolute.com/about/legal/agreements/absolute/

27. HP Connection Optimizer requires Windows 10.

28.HP Support Assistant requires Windows and Internet access.

29. Some features require optional subscription to Tile Premium. Tile application for Windows 10

available for download from the Windows Store. Mobile phone app available for download from App Store and Google Play. Requires

11 and greater or Android 6.0 and greater see https://support.thetileapp.com/hc/en-us/articles/200424778

for more information. HP Tile will function as long as the PC has battery power.

30. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

- 31. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.
- 32. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.
- 33. Windows Defender Opt in and internet connection required for updates.
- 34. HP Fingerprint sensor is an optional feature that must be configured at purchase.
- 35. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details
- 36. HP Sure Start Gen6 is available on select HP PCs.
- 37. HP Sure Run Gen4 is available on select Windows 10 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors
- 38. HP Sure Recover Gen4 is available on select HP PCs and requires an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure

Recover to avoid loss of data

- 39. Firmware TPM is version 2.0.
- 49. HP Sure Sense is available on select HP PCs and is not available with Windows10 Home.
- 50. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Applestore.

54. HP Pro Security Edition is available preloaded on select HP PCs and includes HP Sure Click Pro and

HP Sure Sense Pro. 3-year license required. The HP Pro Security Edition software is licensed under the license terms of the HP End User License Agreement (EULA) that can be found at:

https://h30670.www3.hp.com/ecommerce/common/disclaimer.do#EN\_US as modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for thirty-six (36) months thereafter ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support." HP Pro Security Edition is optimized for the SMB environment and ships pre-configured - manageability is optional.



### **Technical Specifications**

The HP Pro Security Edition supports a limited tool set that can be used by the HP Manageability Integration Kit which can be downloaded from http://www.hp.com/go/clientmanagement.

#### **SMART CARD READER**

Smart Card Reader (Optional)

Smart card standard Dimensions (L x W x H) Smart Card support Smart Card Interface PC/SC 2.0 for Windows smart card standard 0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm) ISO 7816 Class A and AB smart cards

Smart Card Interface with T = 0 and T = 1 support Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM

#### **POWER**

### **Power Supply**

HP Smart 65 W External AC power adapter<sup>40</sup>
HP Smart 65 W USB Type-C® adapter<sup>40</sup>
HP Smart 65 W EM External AC power adapter<sup>40</sup>
HP Smart 45 W External AC power adapter<sup>40</sup>
HP Smart 45 W External AC power adapter, 2-prong (Japan only) 40

#### **Power Cord**

2-wire plug - 1.0m 3-wire plug - 1.0m

#### **Primary Battery**

HP Long Life 3-cell, 56 Wh Polymer<sup>41,51</sup> Supports HP Fast Charge (Up to 50% in 30 minutes)<sup>42</sup>

### **Battery Life**

Up to 14 hours and 45 minutes 43

#### **Battery Weight**

0.47 lb 0.215 kg

- 40. Availability may vary by country.
- 41. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 42. Supports HP Fast Charge with 65W AC Adapter. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 43. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.



### **Technical Specifications**

51. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

### **WEIGHTS & DIMENSIONS**

### **Product Weight**

**Non-Touch** 

Starting at 3.73 lb (1.69 kg)44

#### **Touch**

Starting at 3.84 lb (1.74 kg)44

Product Dimensions (W x D x H) 14.1 x 9.2 x 0.75 in 35.9 x 23.38 x 1.92 cm

44. Weight will vary by configuration.

### **PORTS/SLOTS**

### **Ports**

- 2 SuperSpeed USB Type-C® 5Gbps signaling rate 52
- 2 SuperSpeed USB Type-A 5Gbps signaling rate (1 Charging) 52
- 1 HDMI 2.0b8
- 1 Headphone/microphone combo
- 1 4.5 mm AC power
- 1 nano SIM card slot<sup>45</sup>
- 1 Smartcard reader (Optional)
- 1 Nano Security Lock Slot (Lock sold separately)

### 8. HDMI cable sold separately.

All units have a SIM card slot and icon but units that do not support WWAN are shipped with a non-removable SIM slot plug. 45. All units have a SIM card slot and icon but units that do not support WWAN are shipped with a non-removable SIM slot plug.

52. SuperSpeed USB 20Gbps is not available.



### **Technical Specifications**

### **SERVICE AND SUPPORT**

1-year or 3-year limited warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to <a href="http://www.hp.com/support/batterywarranty">http://www.hp.com/support/batterywarranty</a>/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>. 46

46. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



## **Technical Specifications**

### **SYSTEM UNIT**

Nominal Operating Voltage
Average Operating Power
Integrated graphics
Discrete Graphics
19.5V
2.67W
Yes
15.3W

Max Operating Power Discrete < 65W UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C)

Non-operating 41° to 95° F (5° to 35° C) (writing optical)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine

Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

Operating 0.75 grms
Non-operating 1.50 grms

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard Certifications** 

UL Yes
CSA Yes
FCC Compliance Yes

ENERGY STAR® Select models 47

EPEAT 2019 Gold in United States 48

**ICES** Yes Australia / Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes

**SABS** 

Yes

### **Technical Specifications**

47. Configurations of the HP EliteBook 850 G8 Notebook PC that are ENERGY STAR® certified are identified as HP EliteBook 850 G8 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.

48. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.

### **DISPLAYS**

1. Actual brightness will be lower with touchscreen or Sure View.

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 15.6 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent NWBZ

Outline Dimensions (W x H x D) 350.96 x 205.54 mm (max)
Active Area 344.16 x 193.59 mm (typ.)

Weight 370 g (max)
Diagonal Size 15.6 inch

Thickness 3.0 mm/ 5.0 mm (w/PCB) (max)

Interface eDP 1.2 (2 lane)
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio 600:1 (typ.)
Refresh Rate 60 Hz
Brightness 250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe

Backlight LED

Color Gamut Coverage NTSC 45%

Color Depth 6 bits (Hi FRC supportive w/ condition to enable)

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

Panel LCD 15.6 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent Touch on Panel NWBZ Outline Dimensions (W x H x D) 350.96 x 205.74 mm (max)

Active Area 344.16 x 193.59 mm (typ.)

Weight 380 g (max) Diagonal Size 15.6 inch

Thickness 3.2mm/ 5.2mm (PCB) (max)

Interface eDP 1.2

Surface Treatment Anti-Glare On-cell

Touch Enabled Yes

Contrast Ratio 600:1 (typ.)
Refresh Rate 60 Hz
Brightness 250 nits <sup>1</sup>

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe

Backlight LED

Color Gamut Coverage NTSC 45%
Color Depth 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 15.6 inch FHD (1920x1080) Anti-Glare WLED UWVA sRGB 100percent cg 400nits eDP 1.4+PSR2 bent LP NWBZ Outline Dimensions (W x H x D) 349.52 x 205.42 mm (max)

Active Area 344.22 x 193.62 mm (typ.)

Weight 325g (max)
Diagonal Size 15.6 inch

Thickness 2.6mm / 4.6mm (PCB) (max)

Interface eDP 1.4
Surface Treatment Anti-Glare
Touch Enabled No

Contrast Ratio 1200:1 (typ.) Refresh Rate 60 Hz

Brightness 400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED

Color Gamut Coverage sRGB 100% only for UHD LP

Color Depth 8 bits

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

Panel LCD 15.6 inch UHD (3840x2160) Anti-Glare WLED UWVA sRGB 100percent cg 400nits eDP 1.4+PSR2 bent LP NB2Y Outline Dimensions (W x H x D) 349.52 x 205.42 mm (max)
Active Area 344.22 x 193.62 mm (typ.)

Weight 320 g (max)
Diagonal Size 15.6 inch

Thickness 2.6mm / 4.6mm (PCB) (max)

Interface eDP 1.4
Surface Treatment Anti-Glare
Touch Enabled No

Contrast Ratio 1200:1 (typ.)
Refresh Rate 60 Hz
Brightness 400 nits

Pixel Resolution 3840 x 2160 (UHD)

Format RGB Stripe

Backlight LED

Color Gamut Coverage sRGB 100% only for UHD LP

Color Depth 8 bits

Viewing Angle UWVA 85/85/85

Panel LCD 15.6-in FHD (1920x1080) Anti-Glare WLED UWVA 100% sRGB 1000nits eDP 1.4+PSR HP Sure View Reflect NB2Y bent Outline Dimensions (W x H x D) 349.

**Active Area** 

349.52 x 205.39 max. 344.16 x 193.59 typ.

Weight 370g max Diagonal Size 15.6 inch

Thickness 2.6mm / 4.5mm max. (PCB)

Interface eDP

Surface Treatment Anti-Glare (AG)

Touch Enabled No

Contrast Ratio 1500:1 (typ)
Refresh Rate 60 Hz
Brightness 1000 nits¹

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Backlight LED

Color Gamut Coverage 100% sRGB
Color Depth 8 bits

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

### **STORAGE**

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

SSD 128GB 2280 PCIe-3x2 Three Layer Cell

Form Factor M.2 2280
Capacity 128 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X2

Maximum Sequential Read Up to 1400 ~ 2100 MB/s

Maximum Sequential Write Up to 800 ~ 1200 MB/s

**Logical Blocks** 250,069,680

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

SSD 1TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided

Form Factor M.2 2280
Capacity 1 TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X2

Maximum Sequential Read Up to 3100 ~ 3500 MB/s

**Maximum Sequential Write** Up to 2700 ~ 3037 MB/s

**Logical Blocks** 2,000,409,264

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2



## **Technical Specifications**

SSD 256GB 2280 M2 PCIe-3x4 SS NVMe TLC

Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCle NVMe Gen3X4

 Maximum Sequential Read
 Up to 2800 ~ 3500 MB/s

 Maximum Sequential Write
 Up to 1600 ~ 2200 MB/s

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Value

Form Factor M.2 2280
Capacity 256 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X2

Maximum Sequential Read Up to 2100 ~ 2400 MB/s

Maximum Sequential Write Up to 950 ~ 1400 MB/s

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security (Option); TRIM; L1.2

### **Technical Specifications**

SSD 256GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer Cell

Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

Maximum Sequential Read Up to 2800 ~ 3500 MB/s

**Maximum Sequential Write** Up to 1663 ~ 2200 MB/s

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

SSD 2TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided

Form Factor M.2 2280
Capacity 2 TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

Maximum Sequential Read Up to 3100 ~ 3500 MB/s

**Maximum Sequential Write** Up to 2800 ~ 3000 MB/s

**Logical Blocks** 3,907,029,168

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

## **Technical Specifications**

SSD 512GB 2280 M2 PCIe-3x4 SS NVMe TLC

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

Maximum Sequential Read Up to 3100 ~ 3500 MB/s

**Maximum Sequential Write** Up to 2400 ~ 2956 MB/s

**Logical Blocks** 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Value

Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X2

Maximum Sequential Read Up to 1500 ~ 2400 MB/s

**Maximum Sequential Write** Up to 1000 ~ 1750 MB/s

**Logical Blocks** 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

### **Technical Specifications**

SSD 512GB 2280 PCIe-3x2x2 NVMe+SSD 32GB 3D Xpoint

Form Factor M.2 2280 Capacity 512 GB

 NAND Type
 QLC+3D XPoint

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

Interface PCIe NVMe Gen3X2X2

Maximum Sequential Read Up to 2400 MB/s

Maximum Sequential WriteUp to 1300 MB/sLogical Blocks1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

SSD 512GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer Cell

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

Maximum Sequential Read Up to 3100 ~ 3500 MB/s

Maximum Sequential Write Up to 2400 ~ 2956 MB/s

**Logical Blocks** 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

### **Technical Specifications**

#### **NETWORKING**

rate<sup>5</sup>, vPro®

Intel® Wi-Fi® 6¹ AX201 and Bluetooth® 5.0 802.11ax (2x2) supporting gigabitdata Wireless LAN Standards

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11d
IEEE 802.11h
IEEE 802.11h
IEEE 802.11h
IEEE 802.11k
IEEE 802.11k

**IEEE 802.11v** 

Interoperability

Features Wi-Fi 6 technology

Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** 

•802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

•802.11ax: MCSO ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup> •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification
•IEEE 802.11i

•WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

**Infrastructure (Access Point Required)** 

Roaming

Output Power<sup>2</sup>

IEEE 802.11 compliant roaming between access points

• 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum

• 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum

• 802.11ac VHT80(5GHz): +11.5dBm minimum

### **Technical Specifications**

802.11ac VHT160(5GHz): +11.5dBm minimum
 802.11ax HT40(2.4GHz): +10dBm minimum

• 802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption •Transmit mode: 2.0 W

•Receive mode: 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

•Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> •802.11b, 1Mbps: -93.5dBm maximum

•802.11b, 11Mbps: -84dBm maximum
• 802.11a/g, 6Mbps: -86dBm maximum
• 802.11a/g, 54Mbps: -72dBm maximum
• 802.11n, MCS07: -67dBm maximum
• 802.11n, MCS15: -64dBm maximum
• 802.11ac, MCS0: -84dBm maximum
• 802.11ac, MCS9: -59dBm maximum

•802.11ax, MCS11(HT40): -59dBm maximum •802.11ax, MCS11(VHT160): -58.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED White – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate<sup>1</sup> 2.17 Mbps

BLE: 1 Mbps signaling data rate<sup>1</sup> 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels



### **Technical Specifications**

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology **Microsoft Windows Bluetooth Software** 

Power Management Microsoft Windows ACPI, and USB Bus Support Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

**Train Nudging & Interlaced Scan** 

**BT4.2 ESR08 Compliance** 

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 –Extended Scanner Filter Policies

**LE Data Packet Length Extension** 

**FAX Profile (FAX)** 

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Security & Manageability Intel® vPro® support with appropriate Intel® chipset components

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel

12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 5 or 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.



### **Technical Specifications**

Intel® Wi-Fi® 61 AX201 and Bluetooth® 5.0 802.11ax (2x2), supporting gigabit data rate5 non-vPro®

Wireless LAN Standards

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11i

IEEE 802.11r IEEE 802.11v

Interoperability

Features Wi-Fi 6 technology

**Frequency Band** 

•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** 

•802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCSO ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

• 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup>
•IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

IEEE 802.11 compliant roaming between access points

•WPA2 certification
•IEEE 802.11i

•WAPI

**Network Architecture** 

Models Roaming Ad-hoc (Peer to Peer)

**Infrastructure (Access Point Required)** 

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum

802.11a: +18.5dBm minimum
 802.11n HT20(2.4GHz): +15.5dBm minimum

802.11n HT40(2.4GHz): +14.5dBm minimum
 802.11n HT20(5GHz): +15.5dBm minimum

• 802.11n HT40(5GHz): +14.5dBm minimum

### **Technical Specifications**

• 802.11ac VHT80(5GHz): +11.5dBm minimum • 802.11ac VHT160(5GHz): +11.5dBm minimum • 802.11ax HT40(2.4GHz): +10dBm minimum • 802.11ax VHT160(5GHz): +10dBm minimum

Transmit mode 2.0 W **Power Consumption** 

•Receive mode 1.6 W

•Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> •802.11b, 1Mbps: -93.5dBm maximum

> •802.11b. 11Mbps: -84dBm maximum • 802.11a/q, 6Mbps: -86dBm maximum • 802.11a/g, 54Mbps: -72dBm maximum • 802.11n, MCS07: -67dBm maximum • 802.11n. MCS15: -64dBm maximum • 802.11ac, MCSO: -84dBm maximum • 802.11ac. MCS9: -59dBm maximum

•802.11ax, MCS11(HT40): -59dBm maximum •802.11ax, MCS11(VHT160): -58.5dBm maximum

High efficiency antenna with spatial diversity, mounted in the display Antenna type

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

**Form Factor** PCI-Express M.2 MiniCard with CNVi Interface

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm

1. Type 2230: 2.8 g Weight

2. Type 126: 1.3 q

3.3v +/- 9% Operating Voltage

**Temperature** Operating 14° to 158° F (-10° to 70° C)

> -40° to 176° F (-40° to 80° C) Non-operating

Humidity **Operating** 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED Off - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1 Compliant

**Frequency Band** 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) Channels

**Signaling Data Rate** Legacy: 3 Mbps signaling data rate<sup>1</sup> 2.17 Mbps

BLE: 1 Mbps signaling data rate<sup>1</sup> 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice



### **Technical Specifications**

#### channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Bluetooth Software Supported Link Topology **Microsoft Windows Bluetooth Software** 

Power Management Mi

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Software Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Laver

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

**Train Nudging & Interlaced Scan** 

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

**LE Data Packet Length Extension** 

**FAX Profile (FAX)** 

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).
- 5. Wi-Fi 5 or 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.



### **Technical Specifications**

Qualcomm® Snapdragon™ X55 5G Cat 20 ¹ Technology/ Operating bands

WCDMA/HSDPA/HSUPA/HSPA+ operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL). 869 to 894 MHz (DL) Band 6: 830 to 840 MHz (UL), 875 to 885 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 9: 1750 to 1785 MHz(UL), 1845to 1880 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) LTE FDD/TDD operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL) Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) Band 26: 814 to 849 MHz (UL). 859 to 894 MHz (DL) Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) Band 29: 717 to 728 MHz (DL) Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL) Band 32: 1452 to 1496 MHz (DL) Band 34: 2010 to 2025 MHz (UL/DL) Band 38: 2570 to 2620 MHz (UL/DL) Band 39: 1880 to 1920 MHz (UL/DL) Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 46: 5150 to 5925 MHZ (DL) Band 48: 3550 to 3700 MHZ (UL/DL) Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) 5GNR Sub 6GHZ n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) n41: 2496 to 2690 MHz (UL/DL) n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) n77: 3300 to 4200 MHz (UL/DL) n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL)



### HP EliteBook 850 G8 Notebook PC

### **Technical Specifications**

Wireless protocol 5GNR Air Interface standards

l 3GPP Rel15 5G NR sub-6

LTE Rel14

20 layers and 2 Gbps downlink (DL) throughput – 4 × 4 MIMO

across 5x CA

200 Mbps uplink (UL) throughput - 40 MHz ULCA and 256 QAM

**WCDMA** 

R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

**GPS** Standalone, A-GPS (MS-A, MS-B)

GPS: L1 (1575.42MHz); L5 (1176MHz) **GPS** bands

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz)

Galileo E1 (1575.42); E5a (1176MHz)

Maximum data rates 5G sub 6G: 3.8 Gbps

> LTE: ue-CategoryDL 20, (DL: 2 Gbps) ue-CategoryUL 13, (UL: 150Mbps)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

> LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm

**Maximum power consumption** 5G Sub 6: 2500 mA

> LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

**Form Factor** M.2, 3042-S3 Key B

Weight 9 B

**Dimensions** 

42 mm × 30 mm × 2.6 mm (Length x Width x Thickness)

1. 5G module is an optional feature that must be configured at purchase. AT&T and T-Mobile networks supported in the U.S. Module design for 5G networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 50 and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP, requires activation and separately purchased service contract. Check service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, local environment, network conditions, and other factors. 5G not available on all products, in all regions. Backwards compatible to 4G LTE and HSPA technologies. 5G module planned to be available in select countries, where carrier supported.

Intel® XMM™ 7360 LTE- Technology/Operating Advanced 1

bands

LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700

(Band 4),

850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11),

700 (Band 12), 700 (Band 13)

700 (Band 17), 850 (Band 18), 850 (Band 19), 800 (Band

20), 1450 (Band 21), 850 (Band 26)

700 (Band 28) MHz, 700 (Band 29), 2300 (Band 30), 2100

(Band 66) MHz TDD LTE:

2600 (Band 38), 1900 (Band 39), 2300 (Band 40), 2500

(Band 41) MHz



## **Technical Specifications**

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700 (Band 4), 850

(Band 5), 900 (Band 8) MHz

Wireless protocol 3GPP Release 11 LTE Specification CAT.9, MAX 60MHz

**standards** aggregation BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

**GPS** Standalone, A-GPS (MS-B and LTO)

**GPS bands** GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz,

Beidou 1561.098 ± 2.046 MHz

LTE: 450 Mbps (DL 3CA), 50 Mbps (Upload)

Maximum data rates DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)

HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output LTE: 23 dBm power HSPA+: 23.5 dBm

Maximum powerLTE: 1,200 mA (peak); 900 mA (average)consumptionHSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

Dimensions (Length x Width x Thickness)

42 x 30 x 2.3 mm

1. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions.

NXP NPC300 Near Field Communication Module

**Dimensions (L x W x H)** Module 17 mm by 10 mm by 2.0 mm

Chipset NPC300 System interface I2C



### **Technical Specifications**

ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693

**NFC RF standards** ISO/IEC 18092

ECMA-340 NFCIP-1 Target and

Initiator

ECMA-320 NFCIP-2

Tag Type 1, Type 2, Type3 and Type **NFC Forum Support** 

4, NFCIP-1 and NFCIP-2

ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693

Reader (PCD-VCD) Mode<sup>1</sup>

MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

ISO/IEC 14443 A

Card Emulation (PICC-

VICC) Mode<sup>1</sup>

ISO/IEC 14443 B and B'

**MIFARE** FeliCa

13.56 MHz Frequency

**NFC Modes Supported** Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating temperature -25°C to 80°C

-25°C to 125°C Storage temperature

10-90% operating **Humidity** 5-95% non-operating

Supply Operating voltage 2.7 to 5.5 Volts

I/O Voltage 1.8V or 3.3V

**Power Consumption** (Booster enable, VBAT= 3.3V,  $VCC_BOOST = 5V$ )

Mode Power Consumption, Typical<sup>2</sup>

**Polling** 710.93 mW

**Detected Test Tag Type 1** 152.09 mW

**Detected Test Tag Type 2** 341.26 mW

**Detected Test Tag Type 3** 383.76 mW



### **Technical Specifications**

**Detected Test Tag Type 4** 312.26 mW

Antenna connector, 0.3mm pitch, 7
Antenna connector FPC. Antenna matching is

external to module.

1. With application or UICC support

2. Actual Power Consumption is dependent on NFC antenna and matching circuit and on the particular polling sequence and period configured.

#### **POWER**

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 
 Dimensions
 95x45x26.8mm

 Weight
 unit: 200g +/- 10g

Input

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

**Input frequency range** 47 ~ 63 Hz

**Input AC current** Ma

**Output** 

Max. 1.4 A at 90 Vac

**Output power** 45W **DC output** 19.5V

**Hold-up time** 5ms at 115 Vac input

Output current limit

Connector

<8.0A

Connector

**Environmental Design** 

Operating temperature

4.5mm Barrel Type

32oF to 95oF (0oto 35oC)

Non-operating (storage)

temperature

-4oF to 185oF (-20oto 85oC)

Non-operating (storage)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

**EMI and Safety** Eq:

**Certifications** \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

### **Technical Specifications**

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m 2prong 
 Dimensions
 95x45x26.8mm

 Weight
 unit: 200g +/- 10g

Input

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

**Input frequency range** 47 ~ 63 Hz

Input AC current Max. 1.4 A at 90 Vac

Output

**Output power** 45W **DC output** 19.5V

**Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

Connector

**Connector** 4.5mm Barrel Type

**Environmental Design** 

Operating temperature

32oF to 95oF (0oto 35oC)

Non-operating (storage)

temperature

-4oF to 185oF (-20oto 85oC)

Non-operating (storage)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

 Humidity
 20% to 95%

 Storage Humidity
 10% to 95%

EMI and Safety Certifications Eq

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1

NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8m 
 Dimensions
 88x53.5x21mm

 Weight
 unit: 220g +/- 10g

 Input

### **Technical Specifications**

Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range

47 ~ 63 Hz

Input AC current

1.6 A at 90 VAC and maximum load

Output

Output power 65W

DC output 5V/9V/12V/15V/20V Hold-up time 5ms at 115 Vac input

**Output current limit** 

<8.0A

Connector

-----

Connector

USB Type C

Environmental Design

Operating temperature

32oFto 95oF (Ooto 35oC)

Non-operating

(storage) temperature

-4oFto 185oF (-20oto 85oC)

Non-operating

(storage) temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 5% to 95% **Storage Humidity** 5% to 95%

**EMI and Safety** Eg:

**Certifications** \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 100,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m Dimensions Weight Input

90.0x51x28.5mm unit: 250g +/- 10g

### **Technical Specifications**

**Input Efficiency** 

81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

**Input frequency range** 

47 ~ 63 Hz

Input AC current

1.6 A at 90 VAC and maximum load

Output

Output power 65W

**DC output** 5V/9V/12V/15V/20V **Hold-up time** 5ms at 115 Vac input

**Output current limit** 

**Connector** 

8.0A Max.

**USB TYPE C** 

Connector UCD TVD

**Environmental Design** 

Operating temperature

32°F to 95°F (0°to 35°C)

Non-operating

(storage) temperature

-4°F to 185°F (-20°to 85°C)

Non-operating

(storage) temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications - CE Mark - full compliance with LVD and EMC

directives

- Worldwide safety standards -IEC60950, EN60950, UL60950, UL62368, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

- MTBF - over 200,000 hours at 25°C ambient

condition.

 Dimensions
 102x55x30mm

 Weight
 unit: 250g +/- 10g



### **Technical Specifications**

AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm New EM Input

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range

47 ~ 63 Hz

Input AC current Output

Max. 1.7 A at 90 Vac

Output power 65W 19.5V

**Hold-up time** 5ms at 115 Vac input

Output current limit

<11.0A

Connector

Connector

4.5mm Barrel Type

**Environmental Design** 

Operating temperature

32oF to 95oF (0oto 35oC)

Non-operating (storage) temperature

-4oF to 185oF (-20oto 85oC)

Non-operating (storage) temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

**EMI and Safety** Eg:

\*CE Mark - full compliance with LVD and EMC

directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class

B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient

condition.

AC Adapter 65 Watt Smart nPFC Standard Dimensions Weight 90x51x28.5mm unit: 230g +/- 10g



### **Technical Specifications**

Barrel 4.5mm Right Angle 1.8m Input

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range

47 ~ 63 Hz

Input AC current

Max. 1.7 A at 90 Vac

Output

Output power 65W 19.5V

**Hold-up time** 5ms at 115 Vac input

**Output current limit** 

<11.0A

Connector

ector

Connector

4.5mm Barrel Type

**Environmental Design** 

Operating temperature

32oF to 95oF (Ooto 35oC)

Non-operating (storage) temperature

-

-4oF to 185oF (-20oto 85oC)

Non-operating (storage) temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** Eg:

\*CE Mark - full compliance with LVD and EMC

directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B,

CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient

condition.

Dimensions (H x W x L) Weight 7.0 x 66.5 x 276.3 (0.275 x 2.618 x 10.877 inch)

0.215 kg (0.47 lb)



### **Technical Specifications**

Battery CC 3 Cell 56 Wh Long Life -PL Fast Charge Cells/Type

3cell Lithium-Ion Polymer cell / 615383

Energy

Voltage 11.55V Amp-hour capacity 4.85Ah Watt-hour capacity¹ 56 Wh

Temperature 32° to 113° F (0° to 45° C)
Operating (Charging) 32° to 122° F (0° to 50° C)

Operating (Discharging)

14° to 140° F (-10° to 60° C)

Fuel Gauge LED N/A

**Warranty** Depends on system offering

**Optional Travel** 

Battery Available No

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

### **Fingerprint Reader**

Model

Synaptics Validity VFS7552 touch sensor

Mobile Voltage Operation

3.0V to 3.6V

Operating Temperature 14° – 167°F (-10°-75°C) Current Consumption Image

36mA peak

Low Latency Wait For Finger

950 uA Capture Rate 30 cm/sec ESD Resistance

IEC 61000-4-2 4B (+15KV)

**Detection Matrix** 

200\*1 (Plus another secondary line) / 508 dpi / 10mm sensor area

FRR (False Reject Rate) / FAR

(False Acceptance Rate) FRR ~ 1% @ 1:50K FAR



## Technical Specifications

### **COUNTRY OF ORIGIN**

China



## Options and Accessories (sold separately and availability may vary by country)

_		
Category	Description	Part Number
Cases	HP Prelude Pro Top Load	1X645AA
	HP Prelude Pro Backpack	1X644AA
	HP Business Backpack (17.3")	2SC67AA
	HP Business Case (15.6")	2SC66AA
Docking	HP Thunderbolt Dock 120W G2	2UK37AA
_	HP Thunderbolt Dock 230W G2	2UK38AA
	HP Thunderbolt Dock 120W G2 TAA	2UK37AA
	HP TB Dock w/ Combo Cable (230W)	3TR87AA
	HP TB Dock Audio Module	3AQ21AA
	HP TB Dock 120W G2 cable	3XB94AA
	HP TB Dock G2 combo cable	3XB96AA
	HP TB Dock 230W G2 Cable	3XB95AA
	HP USB-C Mini Dock	1PM64AA
	HP USB-C Dock G5	5TW10AA
	HP USB-C/A Universal Dock G2	5TW13AA
Input/Output	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
input/ output	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Premium Keyboard	Z9N41AA
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Wireless Collaboration Keyboard	Z9N39AA
	HP 935 Creator Wireless Mouse	1D0K8AA
	HP 635 Multi-Device Wireless Mouse	1D0K2AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP X4000b Bluetooth Mouse	H3T50AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP USB Travel Mouse	G1K28AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Wireless Premium Mouse	1JR31AA
	HP USB Premium Mouse	1JR32AA
	HP Elite Presenter Mouse	2CE30AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP UC Wireless Mono Headset	W3K08AA
	HP UC Wireless Duo Headset	W3K09AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP USB-C to DP	N9K78AA

## Options and Accessories (sold separately and availability may vary by country)

	HP USB-C to VGA	N9K76AA
	HP HDMI to VGA	H4F02AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C Travel Hub G2	7PJ38AA
	HP Elite USB-C Hub	4WX89AA
Power	HP 65W Slim AC Adapter	H6Y82AA
	HP 45W Smart AC Adapter	H6Y88AA
	HP 65W Smart AC Adapter	H6Y89AA
	HP 45W 2-prong 4.5 mm DC jack AC Adapter	L6F60AA#ABJ
	HP 45W USB-C Power Adapter	1HE07AA
	HP 65W USB-C Power Adapter	1HE08AA
	65W USB-C Slim Power Adapter	3PN48AA
	HP Notebook Power Bank	N9F71AA
	HP USB-C Essential Power Bank	3TB55AA
Storage	HP USB External DVDRW Drive	F2B56AA
505150	HP 256GB PCI-e 3x4 NVMe M.2 SSD	1D0H6AA
	HP 512GB PCI-e 3x4 NVMe M.2 SSD	1D0H7AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
	HP Sure Key Cable Lock	6UW42AA



## **Summary of Changes**

Date of change:	Version History:		Description of change:
	V1 to V2	Updated	Ports, Battery Life

Copyright © 2020 HP Development Company, L.P. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Intel, Core and Intel vPro are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries. DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries. USB Type-C® and USB-C® are trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark of the U.S. Environmental Protection Agency. Microsoft and Windows are either registered trademarks or trademarks of Microsoft Corporation in the United States and/or other countries.

